

C0805C392KATACTU

Aliases (C0805C392KATAC7800) SMD Comm X8G HT150C, Ceramic, 3,900 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.7 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

0805
2mm +/-0.2mm
1.25mm +/-0.2mm
0.9mm +/-0.10mm
0.7mm MIN
0.5mm +/-0.25mm

4000

Packaging Quantity

-	ZITIITI ' 7 O.ZITIITI	measurement condit
W	1.25mm +/-0.2mm	Tolerance
Т	0.9mm +/-0.10mm	Voltage DC
S	0.7mm MIN	Dielectric Withstandi
В	0.5mm +/-0.25mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change
Packaging	T&R, 180mm, Paper Tape	Reference to +25°C a

Specifications	
Capacitance	3,900 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitut	te - and
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